

0.5Ω Ultra Low ON-Resistance Dual SPDT Analog Switch UM5223 QFN10 1.8×1.4

General Description

The UM5223 is a low on-resistance ($R_{\rm ON}$), dual single-pole/double-throw (SPDT) analog switch operates from a single +1.65V to +4.5V supply. The device's targeted applications include battery powered equipment that benefit from it's low on-resistance.

The UM5223 features two 0.5Ω R_{ON} (max) SPDT switches with 0.15Ω flatness and 0.05Ω matching between channels. The switch offers break-before-make switching (1ns) with t_{ON} < 60ns and t_{OFF} < 40ns at +2.7V.

The switch is available in Pb-free QFN10 package.

Applications

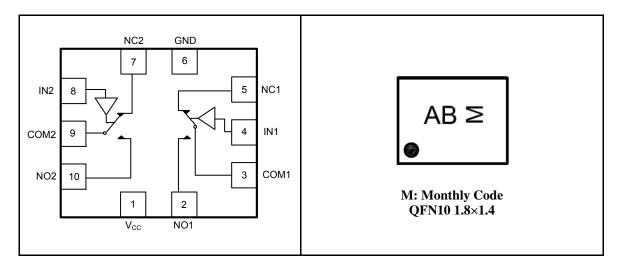
- Cell Phone Audio Block
- Speaker and Earphone Switching
- Portable Instrumentation
- Battery-Operated Equipment
- Modems
- Medical Equipment
- Computer Peripherals
- Ring-Tone Chip/Amplifier Switching

Features

- Ultra-Low Ron<0.5 Ω at Vcc=3.0 \pm 0. 3V
- R_{ON} Flatness of 0.15Ω
- Single-Supply Operation from +1.65V to +4.5V
- Interfaces with 2.8V chipset
- Full 0-Vcc Signal Handing Capability
- Power Off Protection:
 When Vcc=0V, Input Signal Can Tolerate up to 4 5V
- High Off-Isolation: -78dB (100kHz)
- Low Crosstalk: -92dB (100kHz)
- Low Distortion: 0.12%
- High Continuous Current Capability:
 ±300mA through each switch
- Lead (Pb) Free OFN10 Package

Pin Configurations

Top View





Pin Description

Pin	Name	Function			
1	V_{CC}	Positive Supply Voltage			
2	NO1	Analog Switch 1-Normally Open Terminal			
3	COM1	Analog Switch 1 –Common Terminal			
4	IN1	Analog Switch 1-Digital Control Input			
5	NC1	Analog Switch 1-Normally Closed Terminal			
6	GND	Ground Connection			
7	NC2	Analog Switch 2-Normally Closed Terminal			
8	IN2	Analog Switch 2-Digital Control Input			
9	COM2	Analog Switch 2 –Common Terminal			
10	NO2	Analog Switch 2-Normally Open Terminal			

Ordering Information

Part Number	Packaging Type	Marking Code	Shipping Qty
UM5223	QFN10 1.8×1.4	AB	3000pcs/7 Inch Tape & Reel

Function Table

IN_	NO_	NC_		
0	OFF	ON		
1	ON	OFF		

Absolute Maximum Ratings

Symbol	Parameter	Limit	Unit
V_{+}	Supply Voltage	-0.3 to + 5.5	
V_{S}	DC Switch Voltage (Note1)	-0.3 to $(V_+ + 0.3)$	V
IN_	DC IN Voltage	-0.3 to + 5.5	
Io	Continuous Current (COM_, NO_, NC_)	±300	mA
Ip	Peak Current (Pulsed at 1ms, 10% duty cycle)	±500	IIIA
To	Operating Temperature Range	- 40 to +85	
T_{J}	Junction Temperature	+150	°C
T_{STG}	Storage Temperature Range	- 65 to +150	C
$T_{ m L}$	Junction Lead Temperature (Soldering, 10seconds)	+300	
ESD	ESD Method 3015.7	>2000	V

Note1: Signals on COM_, NO_, or NC_ exceeding V₊ or GND are clamped by internal diodes. Limit forward-diode current to maximum current rating.



DC Electrical Characteristics

G 1.1	D	The Control	W. (W)	Vcc(V) Temp	Limits (-40 to 85 °C)			T I '4
Symbol	Parameter	Test Conditions	Vcc(V)		Min	Тур	Max	Unit
I _{IN}	Input Leakage Current	V _{IN} = 3.6V or GND	3.6	Room Full	-0.1 -1.0		0.1 1.0	μA
I_{OFF}	Power Off Leakage Current	V_{IN} = 3.6V or GND	0	Room Full	-0.5 -2.0		0.5 2.0	μA
I _{COM(ON)}	COM ON Leakage Current	$\begin{aligned} V_{IN} &= V_{IL} \text{ or } V_{IH} \\ V_{NO} \ 0.3V \text{ or } 3.3V \text{ with} \\ V_{NC} \ floating \text{ or} \\ V_{NC} \ 0.3V \text{ or } 3.3V \text{ with} \\ V_{NO} \ floating \\ V_{COM} &= 0.3V \text{ or } 3.3V \end{aligned}$	3.6	Room Full	-0.01 -0.1		0.01 0.1	μA
I _{NO/NC(OFF)}	OFF State Leakage Current	$V_{IN} = V_{IL} \text{ or } V_{IH}$ $V_{NO} \text{ or } V_{NC} = 0.3V$ $V_{COM} = 3.3V$	3.6	Room Full	-0.3		0.3	μA
I_{CC}	Quiescent Supply Current	Select and $V_{IS} = V_{CC}$ or GND	1.65 to 3.6	Room Full	-1.0 -2.0		1.0 2.0	μA
V_{IH}	Input High		3.0	Full	1.4			\ \
· III	Voltage		3.6	1 411	1. 7			v
V_{IL}	Input Low Voltage		3.0	Full			0.7	V
· IL	input 20 tt voltage		3.6	1 411			0.8	
R_{ON}	On-Resistance	$V_{IN} = V_{IL}$ or V_{IH} $V_{IS} = V_{CC}$ to GND	3.0	Room Full		0.5 0.6		Ω
Kon	(Note2)	$I_{\text{COM}} = 100 \text{mA}$	Doom	Room Full		0.5 0.6		22
4.0	On Resistance Match Between	$V_{IS} = 1.5 V$ $I_{COM} = 100 \text{ mA};$	3.0	Room Full			0.05 0.05	
$\Delta R_{ m ON}$	Channels (Note2,3,4)	$V_{IS} = 1.8V$ $I_{COM} = 100 \text{ mA}$	3.6	Room Full			0.05 0.05	Ω
D	On Resistance Flatness	$V_{IS} = V_{CC}$ to GND	3.0	Room Full			0.15 0.15	Ω
R _{FLAT}	(Note2,3,5)	$I_{COM}=100 \text{mA}$	3.6	Room Full		_	0.15 0.15	22

Guaranteed by design. Resistance measurements do not include test circuit or package resistance.
 Parameter is characterized but not tested in production.
 ΔR_{ON} = | R_{ON (B0)} - R_{ON(B1)} | measured at identical V_{CC}, temperature and voltage levels.
 Flatness is defined as the difference between the maximum and minimum value of On Resistance over the specified range of ... conditions.



AC Electrical Characteristics

6 1 1	n .	T-4 C 114	V (V)	T	Limits (-40 to 85 °C)			Unit
Symbol	Parameter Test Conditions Vcc(V)		Temp	Min	Тур	Max		
t _{ON}	Turn On Time	$V_{IS} = 1.5V$ $R_L = 50\Omega, C_L = 35pF$	2.3 to 3.6	Room Full		50 60		ns
$t_{ m OFF}$	Turn Off Time	$V_{IS} = 1.5V$ $R_{L} = 50\Omega, C_{L} = 35pF$	2.3 to 3.6	Room Full		30 40		ns
$t_{ m BBM}$	Break Before Make Time (Note 6)	$V_{IS} = 3.0V$ $R_{L} = 50\Omega, C_{L} = 35pF$	3.0	Room Full	2	15		ns
Q_{INJ}	Charge Injection (Note 6)	$C_{L} = 1.0 \text{ nF},$ $V_{GEN} = 0 \text{ V } R_{GEN} = 0\Omega$	1.65 to 3.6	Room		38		pC
$V_{\rm ISO}$	Off Isolation (Note 7)	C_L =5.0pF, f = 100kHz	1.65 to 3.6	Room		-78		dB
VCT	Crosstalk	$R_L=50\Omega, C_L=5.0pF, f$ = 100kHz	1.65 to 3.6	Room		-92		dB
BW	-3 dB Bandwidth		1.65 to 3.6	Room		75		MHz
THD	Total Harmonic Distortion (Note6)	$\begin{aligned} F_{IS} &= 20 \text{Hz to } 20 \text{kHz}, \\ R_L &= R_{GEN} = 600 \Omega \\ C_L &= 50 \text{pF}, \\ V_{IS} &= 2.0 \text{V RMS} \end{aligned}$	3.0	Room		0.12		%
Capacitance	Capacitance							
C _{IN}	IN Pin Input Capacitance (Note8)	$V_{CC} = 3.6V$				4.5		pF
C _{NO/NC}	NO/NC Port Off Capacitance (Note8)	$V_{CC} = 3.6V$				20		pF
Ссом	COM Port Capacitance when Switch is Enabled (Note8)	$V_{CC} = 3.6V$				55		pF

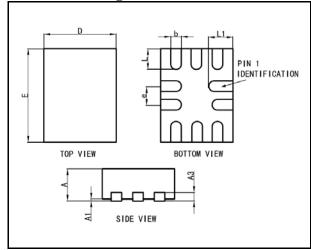
^{6:} Guaranteed by Design.
7: Off Isolation = 20 log10 [V_{COM}/V_{NO/NC}].
8: T_A = +25, f = 1 MHz, Capacitance is characterized but not tested in production.



Package Information

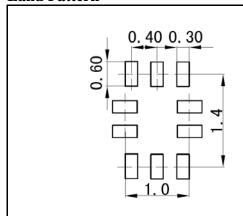
UM5223 QFN10 1.8×1.4

Outline Drawing



DIMENSIONS						
Crimbal	MILLIMETERS					
Symbol	MIN	MAX				
A	0.50	0.55	0.60			
A1	0.00	-	0.05			
A3	0.15REF					
D	1.35	1.40	1.45			
Е	1.75	1.80	1.85			
b	0.15 0.20 0.25					
L	0.30 0.40 0.50					
L1	0.40	0.50	0.60			
e	0.40BSC					

Land Pattern



NOTES:

- 1. Compound dimension: 1.40×1.80;
- 2. Unit: mm;
- 3.General tolerance ±0.05mm unless otherwise specified;
- 4. The layout is just for reference.

Tape and Reel Orientation





IMPORTANT NOTICE

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